

PTC thermistors for overcurrent protection in telecom applications

Single SMDs

Series/Type: B5908*

Date: March 2010

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Single SMDs

SMD

Applications

- Overcurrent protection for telecom applications
- Suitable for line card applications e.g. POTS, access networks, customer premises equipment (CPE) or integrated voice data (IVD)

Features

- Compliant with ITU-T standards
 - basic-level lightning surges (10/700 μs)
 - basic-level power induction (600 V, 1 A, 0.2 s)
 - power contact criteria A/B (230 V, 15 min.)
- Suitable for continuous connection to mains voltages of 110/230 V AC in tripped (high-ohmic) condition
- UL approval for Gamma I version to UL 1434 (file number E69802)
- Matching available with narrow resistance tolerance
- Tight resistance matching maintained after switching
- Negligible resistance drift after reflow soldering or switching
- Marked with type designation and date code
- RoHS-compatible

Options

Alternative tolerances and resistances on request

Delivery mode

■ Blister tape, 330-mm reel with 16-mm (Gamma I), taping to IEC 60286-3

General technical data

Max. operating voltage		V_{max}	245	V AC
Operating temperature range	(V = 0)	T _{op}	-20/+125	°C
Operating temperature range	(V = 230 V)	T _{op}	0/+70	°C



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Electrical specifications and ordering codes

Туре	R_R	ΔR_R	R _{25,match}	I _R	I _R	Is	I _{Smax}	Ordering code
			(per packing unit)	@	@	@	@ 230 V AC	
			$ R_1 - R_2 _{max}$	25°C	70°C	25°C		
	Ω	%	Ω	mA	mA	mA	Α	
Gamma	ı I							
G1081	9	±20	0.5	180	120	400	1.0	B59081G1120A161
G1085	10	±20	1.0	180	120	400	1.0	B59085G1120A161
G1083	16	±20	0.5	150	100	300	1.5	B59083G1120A161
G1080	25	±20	1.0	130	85	270	2.8	B59080G1120B262
G1086	29	±20	1.0	125	80	260	2.8	B59086G1120B262
G1084	50	±15	1.0	90	60	190	2.5	B59084G1120A161

Switching times and ordering codes

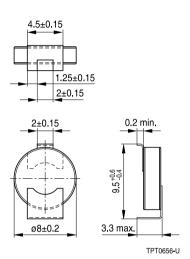
Туре	R _R	t _S (typ.) @ I _{Smax,} 230 V AC	t _s (typ.) @ 1 A, 230 V AC	t _s (typ.) @ 500 mA, 230 V AC	Ordering code
	Ω	S 200 V AO	S 200 V AO	S S	
Gamma	i				
G1081	9	4.4	4.4	23.0	B59081G1120A161
G1085	10	3.9	3.9	19.0	B59085G1120A161
G1083	16	1.0	2.4	11.0	B59083G1120A161
G1080	25	0.2	1.5	6.5	B59080G1120B262
G1086	29	0.18	1.3	5.5	B59086G1120B262
G1084	50	0.13	0.8	3.1	B59084G1120A161



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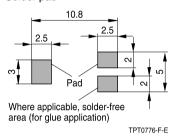
Dimensional drawings for Gamma I

Dimensions in mm



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Solder pad



Packaging

Туре	Packaging	Packaging		
Gamma I				
G1080	16-mm tape			
G1081	16-mm tape			
G1083	16-mm tape			
G1084	16-mm tape			
G1085	16-mm tape			
G1086	16-mm tape			



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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 20%
cycling		Number of cycles: 10	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op,max} (V _{max})	< 25%
constant		Test duration: 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 \text{ V}), T_2 = T_{op,max} (0 \text{ V})$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, Test Na	
Vibration	IEC 60738-1	Frequency range: 10 to 55 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3 × 2 h	
		Test according to IEC 60068-2-6, Test Fc	
Shock	IEC 60738-1	Acceleration: 390 m/s ²	< 5%
		Pulse duration: 6 ms; 6 × 4000 pulses	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max}(0 \text{ V})$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 \text{ V})$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	



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ITU performance overview and test conditions

	Toot	ITU K20		ITU K21		ITU K45	
	Test no.	Basic test level	Enhanced test level	Basic test level	Enhanced test level	Basic test level	Enhanced test level
Power induction	1	Α	Α	Α	Α	Α	Α
	2	В	С	В	С	В	С
Power contact	3	D	E	D	E	D	E
Lightning surge	4	F	G	G	G	G	G
	5	Н	Н	Н	1	Н	Н

	Α	600 V AC, R = 600 Ω, t = 0.2 s, criteria A
Power induction	В	600 V AC, R = 600 Ω , t = 1.0 s, with GDT, criteria A
	С	1500 V AC, R = 200 Ω , t = 2.0 s, with GDT, criteria A
Power contact	D	230 V AC, t = 15 min, R = 10 1000 Ω, criteria B
	_	230 V AC, t = 15 min, R = 10, 20, 40, 80, 1000 Ω, criteria B,
	E	R = 160, 300, 600 Ω , criteria A
Lightning surge	F	$U_{c(max)}$ = 1.0 kV, R = 25 Ω , t = 10/700 μ s, without GDT, criteria A
	G	$U_{c(max)} = 1.5$ kV, R = 25 Ω , t = 10/700 μ s, without GDT, criteria A
	Н	$U_{c(max)} = 4.0$ kV, R = 25 Ω , t = 10/700 μ s, with GDT, criteria A
	I	$U_{c(max)} = 6.0$ kV, R = 25 Ω , t = 10/700 μ s, with GDT, criteria A

Criteria A: no damage, function must be fulfilled.

Criteria B: no fire hazard.

Electrical requirements according to GR1089 standard for AC power contact

AC voltage: 120 V, 50 Hz, short circuit current 25 A, time 15 min, criteria A.



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature −25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).



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Symbols and terms

Α Area

Cth Heat capacity Frequency ı Current

 I_{max} Maximum current l_R Rated current I_{PTC} PTC current l, Residual currrent

Residual currrent in oil (for level sensors) I_{roil} Residual currrent in air (for level sensors) $I_{r,air}$ Root-mean-square value of current

I_{RMS}

 I_{S} Switching current

I_{Smax} Maximum switching current LCT Lower category temperature

Ν Number (integer)

 N_c Operating cycles at V_{max}, charging of capacitor

Nμ Switching cycles at V_{max}, failure mode

Р

Pas Maximum power at 25 °C

 P_{el} Electrical power P_{diss} Dissipation power R_{min} Minimum resistance R_{R} Rated resistance ΔR_{R} Tolerance of R_R Parallel resistance R_P R_{PTC} PTC resistance Reference resistance R_{ref} Series resistance R_s

R_{25,match} Resistance matching per reel/ packing unit at 25 °C

 ΔR_{25} Tolerance of R₂₅ Т Temperature

t Time

 R_{25}

 T_{A} Ambient temperature Thermal threshold time ta

 $T_{\rm C}$ Ferroelectric Curie temperature

Resistance at 25 °C



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t_E Settling time (for level sensors)

 $\begin{array}{lll} T_{\text{R}} & & \text{Rated temperature} \\ T_{\text{sense}} & & \text{Sensing temperature} \\ T_{\text{op}} & & \text{Operating temperature} \\ T_{\text{PTC}} & & \text{PTC temperature} \\ t_{\text{R}} & & \text{Response time} \end{array}$

T_{rof} Reference temperature

T_{Bmin} Temperature at minimum resistance

t_s Switching time

T_{surf} Surface temperature

UCT Upper category temperature

V or V_{el} Voltage (with subscript only for distinction from volume)

V_{RMS} Root-mean-square value of voltage

 V_{BD} Breakdown voltage V_{ins} Insulation test voltage $V_{link,max}$ Maximum link voltage V_{max} Maximum operating voltage

V_{max dvn} Maximum dynamic (short-time) operating voltage

V_{meas} Measuring voltage

V_{meas.max} Maximum measuring voltage

V_B Rated voltage

V_{PTC} Voltage drop across a PTC thermistor

 $\begin{array}{lll} \alpha & & \text{Temperature coefficient} \\ \Delta & & \text{Tolerance, change} \\ \delta_{\text{th}} & & \text{Dissipation factor} \end{array}$

 τ_{th} Thermal cooling time constant

λ Failure rate

e Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.



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B59874C120A70 B59960C160A70 YQD120N0025 PTGL12AS4R7K6B51B0 PTGL12AR270M9C01B0 PTGL12AR100M6C01B0

PTGL09AR390N0B52A0 PTGL07AS2R7K2B51A0 PTGL07AS1R8K2B51B0 PTS120601B100RPU00 PTGL10AR3R9M3P51B0

PTGL07BD220N3B51B0 PTGL07AS5R6K4B51B0 PTGL07AS150K6B51A0 PTGL07AR8R2M3P51B0